ISAAT2005	(International S	vmnoeium on	Advances in	Abracivo	Technology	2005)	(Provisional)
13AA 1 2003	(international S	ymposium on	Auvances in	ADIASIVE	reciniology,	2003)	(FIUVISIUIIAI)

20, June (Monday)		21, June (Tuesday)				
9:00	g	Room A	Room B			
9:10	g	:10				
9:20	g	20				
9:30	g	30				
9:40	g	40 Plenary Session				
9:50	g	St. Petersburg Government 50 St. Petersburg State Polytechnic University				
10:00	10	:00				
10:10	10	:10				
10:20	10	.20				
10:30	10	:30				
10:40	10	:40				
10:50	10	50 Coffee Break				
11:00	11	¹⁰⁰ I. Advanced Grinding Technologies (1)	VIII. Cutting Performance and its Mechanism			
11:10	11	Development of New Device for Form-Grinding and Research on the Profile- 10 Accuracy 0.5 Your LY Keng N.O. Wu S.P. Chan 3.O. Zhang and 3.D. Zhang	MQL Cutting of Inconel 718 with a Super Lattice Coating Tool T. Obikawa and Y. Kamata			
11:20	11	20 Adaptive Table-Motion Control of a Surface Grinding Machine Using an AE	High-Speed Milling Experiments on the Extended Length of Milling Tool			
1130	1	Sensor 30 A. Yui, S. Okuyama and T. Kitajima	Z. Qin, C.Y. Wang, Y.N. Hu and Y.S. Lin			
11:40	11	40 An Adaptive Control of Machine Table Reciprocation Using a Hydrophone - A	Drilling Assisted by Ultrasonic Elliptical Vibration			
11:50	11	50 S. Okuyama, M. Hayashi, A. Yui and T. Kitajima				
12:00	12	00 Abrasive Technology of Single-Crystal Diamond by Diamond Abrasive Wheel	Study on Ultrasonic Vibration Drilling of Particulate Reinforced Aluminium Matrix Composites			
12:10	12	10	C.S. Liu, B. Zhao, G.F. Gao and X.H. Zhang			
12:20	12	20 Effects of TiH2 on the Properties of Fe-Based Diamond Composites Q.L. Dai and X.P. Xu	Enhancing the AWJ Cutting Performance by Multipass Machining with Controlled Nozzle Oscillation			
12:30	12	30	J. Wang and S. Xu			
12:40	12	40 Effect of Ultrasonic Elliptic Vibration on Friction between Shoe and Workpiece in Ultrasonic Elliptic-Vibration Shoe Centerless Grinding	Mathematical Models for the Hydrodynamic Characteristics of Abrasive Wateriets			
12:50	12	50 Y. Wu, Y. Fan, T. Tachibana and M. Kato	J. Wang and H. Liu			
13:00	13	OD Eco- and Energy-Efficient Grinding Processes B. Denkena, M. Reichstein, N. Kramer, J. Jacobsen and M. Jung	Prevention from Delamination of Composite Material during Drilling Using Ultrasonic Vibration			
13:10	13	10	S. Aoki, S. Hirai and T. Nishimura			
13:20	13	20 Study on Ultrasonic Vibration Grinding Character of Nano ZrO2 Ceramics B. Zhao, X.H. Zhang, C.S. Liu, F. Jiao and X.S. Zhu	Influence of Material of Small Radius Ball End Mill on Cutting Accuracy in Deep Precision Machining			
13:30	13	30	T. Akamatsu, K. Kitajima, S. Minamino and T. Kiriyama			
13:40	13	⁴⁰ New Compensation Grinding of Axisymmetrical Aspherical Lenses with High NA Value	Study on Surface Integrity of PTFE Finished by Ultra-Precision Cutting and Surface Performance			
13:50	13	⁵⁰ N. Yoshihara and T. Kuriyagawa	K. Okuda and M. Nunobiki			

20, June (Monday)		21, June (Tuesday)					
			Room A	Room B			
14:00		14:00					
14:10		14:10					
14:20		14:20					
14:30		14:30	Lunch				
14:40		14:40					
14:50		14:50					
15:00		15:00	I. Advanced Grinding Technologies (2) A New Diamond Wheel Containing Boron Doped Diamond Abrasives Enabling	IX. Advanced Machine Tools, Cutting, and Abrasive Tools Comparative Study on Machining the Internal Stationary Toroidal Gear			
15:10		15:10	Electrically Conductive Cutting Edge and High Thermal Stability	L. Yao, G.W. Wei, Z.H. Lan and J.S. Dai			
15:20		15:20	Attempt of Electrodischarge Grinding with an Electrically Conductive Diamond- Cutting-Edge Wheel	Studies on NC Machining for Cylindrical Cams			
15:30		15:30	K. Suzuki, S. Ninomiya, M. Iwai, Y. Tanaka, Y. Murakami, S. Sano, K. Tanaka and T. Lematsu				
15:40		15:40	Ultra-High Speed Grinding Using a CBN Wheel for a Mirror-Like Surface	Dynamic Analysis of a Biglide Parallel Grinder P. Zou			
15:50		15:50	M. Ota, T. Nakayama, K. Takashima and H. Watanabe				
16:00		16:00	Ultraprecision Fabrication of Large-Scale SiC Spherical Mirror Using ELID Grinding Process	A New Architecture of Tool Path Generation for Five-Axis Control Machining K. Nakamoto, K. Shirase, A. Morishita, E. Arai and T. Moriwaki			
16:10		16:10	Y. Dai, H. Ohmori, W. Lin, H. Eto and N. Ebizuka	· · · · · · · · · · · · · · · · · · ·			
16:20	Early	16:20	XII. Inspection and Manufacturing Technologies Fault Monitoring and Diagnosis of Ball Bearing Based on Hilbert-Huang	Development of Orthogonal Impact Cutting Testing Machine J. Shinozuka and T. Obikawa			
16:30	Registration	16:30	Transformation H. Li, H.Q. Zheng and L.W. Tang				
16:40		16:40	Hilbert-Huang Transform and Its Application in Gear Faults Diagnosis H. Li. H.Q. Zheng and L.W. Tang	Research of the Technological Parameters Influencing on the Surface Quality of Micro Complex Surface			
16:50		16:50		M.J. Chen, Y.C. Liang, Y.Z. Sun, W.X. Guo and W.J. Zong			
17:00		17:00	An Optimal Matching Algorithm Based on Rough Localization and Exact Adjustment	The Effect of Secondary Piezoelectric Effect on the Measuring Precision of Quartz Dynamometers			
17:10		17:10	Y.W. Sun and J.T. Xu	L.P. Shi, B.Y. Sun and M. Qian			
17:20		17:20	Study on Key Technologies of DNC System Oriented Networked Manufacturing	Development of Shrinking Tool Holder Utilizing of Shape Memory Alloy K. Kitajima, H. Sogabe and M. Hiromi			
17:30		17:30	M.J. Wang, Y.J. Cai and W.G. Yan				
17:40		17:40	Wavelet Transform Based 3D Scattered Data Processing in Binocular Micro Stereovision System	Microstructure of Ni-Al-Diamond Composite Fabricated by Self-Propagating High Temperature Synthesis			
17:50		17:50	C. Liu, W. Pei, Z.Y. Xia, S. Niyokindi, J.C. Song and L.D. Wang	F.L. Zhang, H. Yuan, C.Y. Wang, K.X. Fu and Y.M. Zhou			
18:00		18:00					
18:10		18:10					
18:20		18:20					
18:30		18:30	Welcome Party				

	22, June (Wednesday)						
	Room A	Room B					
9:00	V. Deburring and Finishing (1)	X. EDM, ECM and USM (1)					
0.40	Analysis of Burr Formation Mechanism in Turning Aluminium Alloy Al6061-T6	Electroforming of Copper/ZrB2 Composite Coatings and Its Performance as					
9:10	A. Toropov, SL. Ko and BK. Kim	Electro-Discharge Machining Electrodes					
9.20		Z.J. Jin, M. Zhang, D.M. Guo and R.K. Kang Performance of an Electrically Conductive CVD Diamond Electrode for EDM					
0.20		and FEM Analysis for a Very Low Wear					
9:30	Effective Deburring of Micro Burr Using Magnetic Abrasive Finishing Method	K. Suzuki, M. Iwai, A. Sharma, S. Ninomiya, T. Uematsu and S. Sano					
	J.I. Park, SL. Ko, Y.H. Hanh and Y.M. Baron						
9:40		A New Application of PCD as a Very Low Wear Electrode Material for EDM					
		K. Suzuki, A. Sharma, S. Sano, M. Iwai and T. Uematsu					
9:50	Improvement of Surface Texture of Stainless Steel by Utilizing Dry Blasting -						
	2nd Report: Effect of Blasting Conditions on Wettability -						
10:00	K. Minaki, K. Kitajima, K. Minaki, M. Izawa and K. Tosha	A Study of Sufface Integrity in WEDM-HS with Air Medium					
10.10	Abaratian Obarattaistian an Miner Finishing bu Aluming Fiber Devel						
10.10	Abrasive Characteristics on Mirror Finishing by Alumina Fiber Brush						
10.20	N. Ishinawa, H. Suwabe and F. Fulae	Calculating the Overcut in Electro-Discharge Machining					
		F.L. Zhao, H. Wang and Z.Z. Lu					
10:30		······································					
10:40							
	Coffee Break						
10:50							
11:00	V. Deburring and Einishing (2)	II. Grinding Performance and its Mechanism (1)					
11.00	V. Deburning and Finishing (2)	Studies on CCD On-Line Measurement System for Grinding Wheel Wear					
11:10	J.C. Fang, W.J. Xu, Z.Y. Zhao and H.Y. Li	Y.H. Zhang, H.Q. Tang and D.J. Hu					
11:20	Study on Internal Magnetic Field Assisted Finishing Process Using a Magnetic	Wear of Metal-Bonded Diamond Tools in Different Abrasive Processes					
	Machining Jig	X.P. Xu, Q.L. Han and Y. Li					
1130	Y. Zou and T. Shinmura						
11.40	Development of Oce Atomics d Mensolis Teals	Circuit Analysis of Accuratis Enviroing for Lance Instanting Onio Jing Durr					
11.40	T Saito K Koike H Yamato A Kuwana A Suzuki H Yamaguchi and T	X Chen, O, Liu and N, Gindy					
11:50	Shinmura	X. Orion, Q. Eld and W. Orioy					
	on minute						
12:00	Characterization of the Magnetic Abrasive Finishing Method and Its Applicatior	Analysis of Grinding Temperature Considering Surface Generation Mechanism					
	to Deburring	T. Obikawa and J. Shinozuka					
12:10	Y.M. Baron, SL. Ko and J.I. Park						
10.00							
12:20	Technique of Comparison and Optimization of Conditions for Magnetic	Noise and Vibration of Diamond Sawblade for Concrete Dry Cutting					
12.30	Abrasive Finishing	C.Y. Wang, Y.N. Hu, Z.W. Wang and H.N. Ding					
12.50	T.W. Dalon, SL. Ro and J.I. Park						
12:40		Force Characteristics in Ultrasonic Vibration Grinding of Nanoceramics					
		Y. Wu, B. Zhao and X.S. Zhu					
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	Lunah						
13:30	Lunch						
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	22, June (Wednesday)					
	Room A	Room B				
14:00 14:10	V. Deburring and Finishing (3) Finishing of Shape Surfaces by Magnetic Abrasive Polishing Method with Rotating Working Area	II. Grinding Performance and its Mechanism (2) Experimental Research on ELID Grinding and Cutting Performance of Nano Cemented Carbide Cutters F.H. Zhang, J.C. Gui, Y.Z. Liu and H.L. Zhang				
14:20	V.A. Litvinenko	ELID Grinding Properties of High-Strength Reaction-Sintered SiC Y. Dai, H. Ohmori, W. Lin, H. Eto, N. Ebizuka and K. Tsuno				
14:30	Mechanics of the Micro Cutting by Abrasive Particle at Vibro-Abrasive Processing					
14:40 14:50	A.P. Babichev	Characterization of ELID-Ground Granite Surfaces J.Y. Shen, W. Lin, H. Ohmori and X.P. Xu				
15:00						
15:10	Quality of Deburring and Surface Finishing (DSF) in Russia A.P. Babichev	Surface Quality improvement of Aspherical Pressing Mould Using Parallel Grinding Method F.H. Zhang, L.J. Li and S. Dong				
15:20		Effect of Cutting Edge Truncation on Ground Surface Morphology of Hard and Rrittle Materials for Ontical Devices				
15:30		X. Kang, J. Tamaki, A. Kubo, J. Yan and T. Iyama				
15:40						
15:50	Coffee Break					
16:00	V. Deburring and Finishing (4)	II. Grinding Performance and its Mechanism (3)				
16:10	The Optimization of Technological Processes of Detail Processing by Free Abrasives M A Tamarkin	Experimental Research on ELID Grinding and Cutting Performance of Nano Cemented Carbide Cutters E H. Zhang, J.C. Gui, Y.Z. Liu, and H.L. Zhang				
16:20		Reliability Prediction of Centerless Grinding Machine S.W. Lee, HZ. Choi, S.H. Nam and Y.J. Choi				
16:30						
16:40	X. EDM, ECM and USM (2)	A Comprehensive Evaluation Model for Assessments of Grinding Machining				
16:50	Research on Highly Efficient EDM Pulse Power Supply and its Experiments Y.K. Wang, B.Y. Song and W.S. Zhao	Quality HZ. Huang, YH. Li and LH. Xue				
17:00	The Research of Carbon Steel Surface Finished by Pulse Electrochemical Finishing Technology	Analysis of the Grinding Mechanism with Wheel Head Oscillating Type CNC Crankshaft Pin Grinder				
17:10	H. Wang, J.J. Zhou and W.J. Xu	T. Fujiwara, S. Tsukamoto and M. Miyagawa				
17:20 17:30	Study on the Machined Surface Topography and Performances on Electrochemical Finishing H.Y. Li, X.M. Liu, H.J. Liu and J.C. Fang	XI. Forming and the Related Novel Technologies (1) Graph-Analytic Modification of the Method of Upper Estimation (Method of Energetic Geometry) A.A. Alexandrov and V.V. Evstifeev				
17.40	Effect of Tool Segmentation in Ultrasonic Machining - Studies of Ultrasonic Die Sinking -					
17:50	O. Saito and T. Kuriyagawa	Features of Application of the Laser Method for Normalization of Accuracy of Resistors in Hybrid Integrated Circuits				
18:00		Y. Antonov				
18:10						
10.20						
18:30	Evening Excursion of St. Petersburg					

	23, June (Thursday)				
	Room A	Room B			
9:00 9:10	III. Dressing and Truing of Grinding Wheels (1) Investigation on the Dressing Shape of Vacuum Chuck in Wafer Rotation Grinding	VI. Lapping and Polishing (1) Lapping Machining of High-Speed and High-Precision Ceramic Bearing Balls Y.H. Wu, S.H. Li and K. Zhang	9:00 9:10		
9:20	H. Gao, Y.B. Tian, Z.Y. Jia and R.K. Kang Energy-Mode Adjustment in Laser Processing a Small Vitrified CBN Grinding	Time Series Analysis for the Mechanical Lapping of Single Crystal Diamond	9:20	Meeting of Organizing	
9:30	Wheel X.Y. Wang, Y.B. Wu, R.K. Kang, J. Wang, W.J. Xu and M. Kato	Cutting Loois W.J. Zong, D. Li, H.X. Wang, T. Sun, K. Cheng and M.J. Chen	9:30	Meeting of ICAT	
9:40	Effects of Ultrasonic Vibration in Truing and Dressing of CBN Grinding Wheel Used for Internal Grinding of Small Holes	Effects of Particles Blend Ratio on Surface Quality in Surface Polishing Using Magnetic Polishing Liquid (MPL)	9:40		
9:50	M. Nomura, Y. Wu, M. Kato and T. Kuriyagawa	Y. Wu, K. Shimada, Y.C. Wong and M. Kato	9:50		
10:00	A Study on the Optimum Condition Selection of Rotary Dressing System of Ultra-Precision Centerless Grinding Machine for Ferrule	Fundamental Verification of Ultraviolet-Excited Abrasion and Polishing Characteristics of Copper - Study of Luminescence Machining -	10:00		
10:10	ES. Lee, YJ. Chun and NK. Kim	Y. Chiwaya and T. Tanaka	10:10		
10:20	Dressing Monitoring by Acoustic Emission B. Denkena, J. Jacobsen and N. Kramer	Ultra-Precision Finishing of Micro Aspherical Surface by Ultrasonic Vibration Assisted Polishing	10:20		
10:30		H. Suzuki, R. Kawamori, M. Miyabara, T. Okino, Y. Hijikata, Y. Yamamoto, K. Nakamoto, T. Moriwaki and H. Shibutani	10:30		
10:40	Coffee Break		10:40		
10:50			10:50		
11:00	III. Dressing and Truing of Grinding Wheels (2) Dressing of Vitreous Bonded Wheels for Continuous Generating Grinding of	VI. Lapping and Polishing (2) Characteristics of High Rotational Speed Polishing with Oscillation Speed	11:00		
11.10	B. Denkena, M. Reichstein and F. Catoni B. Denkena, M. Reichstein and F. Catoni	K. Yoshitomi, A. Une and M. Mochida	11.10		
1130	Report: Principle & Fundamental Experiments) H. Ohmori, S. Yin, W. Lin, Y. Uehara, S. Morita, M. Asami and M. Ohmori	S. Suzuki, N. Yoshihara and T. Kuriyagawa	1130		
11:40	Development on Micro Precision Truing Method of ELID-Grinding Wheel (2nd	Polishing Characteristics of ELID-Ground Surface of Nano Precision Optical	11:40		
11:50	Report: Application to Edge Sharpening of Large Wheel) S. Yin, W. Lin, Y. Uehara, S. Morita, H. Ohmori, M. Asami and M. Ohmori	Elements W. Lin, H. Ohmori, T. Suzuki, Y. Uehara and S. Morita	11:50	Exercise to Detergraff	
12:00	IV. Coolant and Cooling in Grinding (1) Study on Lubricating and Cooling Effects of Savaral Cooling Systems Used in	Precision Abrasive Jet Finishing of Cemented Carbide	12:00	(Optional tour)	
12:10	Face Grinding T Tanaka and T Kohavashi		12:10		
12:20	A New Coolant Supply Method Using a Coolant Flow Guided Flexible Sheet Attracted to a Wheel Surface	VII. Wafer Processing and Nano Processing (1) Measurement of Surface Roughness and Thickness of Silicon Wafers Using	12:20		
12:30	K. Suzuki, S. Ninomiya, M. Iwai, Y. Shishido and T. Uematsu	an Infrared Laser S. Koshimizu	12:30		
12:40	Effects of Actively Cooled Coolant for Grinding Brittle Materials Y. Gao, H. Lai and S. Tse	Investigation of Chemical Mechanical Polishing of GaAs Wafer by the Effect of a Photocatalyst	12:40		
12:50		S.H. Hong, H. Isii, M. Touge and J. Watanabe	12:50		
13:00			13:00		
13:10			13:10		
13:20	Lunch		13:20		
13:30			13:30		
13:40			13:40		
13:50			13:50		

	24, J	une (Friday)			
	Room A Room B				
14:00	IV. Coolant and Cooling in Grinding (2) Soap Mist Jet Cooling of Grinding Processes	VII. Wafer Processing and Nano Processing (2) Machining Mechanisms of Si Wafers in Mechanochemical Polishing by Soft	14:00		
14:10	D.M. Babic, A.A. Torrance and D.B. Murray	Abrasives N. Yasunaga	14:10		
14:20	Trends in Fluid Application Strategy for Grinding Processes	Friction Characteristic of Wafer Surface in Chemical Mechanical Polishing Z.Y. Jia, J.X. Su, Z.J. Jin, D.M. Guo and L.P. Li	14:20		
14:30			14:30		
14:40	XI. Forming and the Related Novel Technologies (2) Study of Rapid Casting Process Based on SLS Prototypes	Corrosion Inhibiting Effect on Copper Chemical Mechanical Planarization (CMP) in Fe(NQ3)3 Based Slurries	14:40		
14:50	H.J. Liu, Y.M. Li, Y. Hao, X.P. Dong and N.Y. Huang	D.M. Guo, X.J. Li, Z.J. Jin and R.K. Kang	14:50		
15:00	Study on the Dimensional Precision of the Polymer SLS Prototype	Nano Mechanical Processing of Silicon by Atomic Force Microscopy S. Miyake, M. Wang and J. Kim	15:00		
15:10	······································		15:10		
15:20	Arc Spray Forming of Stainless Steel Mould	Application of Nanometer-Scale Processing Technique in High-Density	15:20		
15:30		M. Wang and S. Miyake	15:30		
15:40			15:40		
15:50	Coffee Break		15:50	Excursion to Peterscoff	
16:00	XI. Forming and the Related Novel Technologies (3) FGM Mould with Fine Veins Rapidly Manufactured by Plasma Spraving	VII. Wafer Processing and Nano Processing (3) Optimization of the Chemical Vanor Deposition Induced Focused Ion Ream	16:00	(Optional tour)	
16:10	J.C. Fang, W.J. Xu, Z.Y. Zhao and L. Wang	HZ. Choi, EG. Kang, SW. Lee and WP. Hong	16:10		
16:20	Application of Neural Network in Plasma-Arc Flexible Forming W.J. Xu. J.C. Fang, F. Liu, X.Y. Wang and Z.Y. Zhao	Thinning Technology of Patterned Silicon Wafer for Micro Pressure Sensor T. Nagano, M. Touge and J. Watanabe	16:20		
16:30			16:30		
16:40	Numerical Simulation of the Cooling Process of Extruded Plastic Profiles within Vacuum Calibrators	Study on the Surface and Subsurface Integrity of Ground Monocrystalline Silicon Wafers	16:40		
16:50	D.Y. Zhao, M.J. Wang and M.C. Song	R.K. Kang, Y.X. Zhang, D.M. Guo and Z.J. Jin	16:50		
17:00	A Novel Automatic Feed-Rate Adjustment Method for Die-Cavity Roughing M.J. Wang, Y.J. Cai and W.G. Yan		17:00		
17:10			17:10		
17:20	Deformation Analysis of Fixturing for Workpiece with Complex Geometry Y. Wang, X. Chen and N. Gindy		17:20		
17:30			17:30		
17:40			17:40		
17:50			17:50		
18:00			18:00		
18:10					
18:20	Banquet				
18:30					